

General Description

The IRF4905 uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.

Features

- P-Channel
- Fast Switching
- Simple Drive Requirements
- RoHS Compliant

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-60	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current	-75	A
I_{DM}	Pulsed Drain Current	-225	A
EAS	Single Pulse Avalanche Energy	1150	mJ
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	200	W
T_{STG}	Storage Temperature Range	-55 to 175	°C
T_J	Operating Junction Temperature Range	-55 to 175	°C

Thermal Data

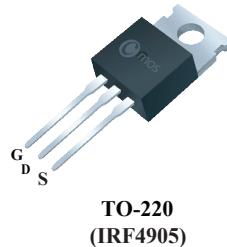
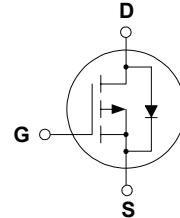
Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-case	---	0.75	°C/W

Product Summary

BVDSS	RDSON	ID
-60V	9mΩ	-75A

Applications

- Inverters
- Motor drive
- DC / DC converter

TO-220 Pin ConfigurationTO-220
(IRF4905)

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$	-60	---	---	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=-10\text{V}$, $I_D=-20\text{A}$	---	---	9	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_D=-10\text{A}$	---	---	11	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	-1	---	-2.5	V
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=-60\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	-100	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$, $I_D=-15\text{A}$	---	27	---	S
Q_g	Total Gate Charge	$I_D=-38\text{A}$	---	150	---	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=-44\text{V}$	---	25	---	
Q_{gd}	Gate-Drain Charge	$V_{\text{GS}}=-10\text{V}$	---	70	---	
$T_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DS}}=-28\text{V}$	---	20	---	ns
T_r	Rise Time	$I_D=-38\text{A}$	---	100	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time	$R_G=2.5\Omega$	---	60	---	
T_f	Fall Time	$R_D=0.72\Omega$	---	95	---	
C_{iss}	Input Capacitance	$V_{\text{DS}}=-25\text{V}$, $V_{\text{GS}}=0\text{V}$, f=1MHz	---	12000	---	pF
C_{oss}	Output Capacitance		---	1000	---	
C_{rss}	Reverse Transfer Capacitance		---	450	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	-75	A
I_{SM}	Pulsed Source Current		---	---	-225	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_s=-10\text{A}$, $T_J=25^\circ\text{C}$	---	---	1.2	V
t_{rr}	Reverse Recovery Time	$I_F=-38\text{V}$, $T_J=25^\circ\text{C}$ $dI_F/dt=100 \text{ A}/\mu\text{s}$	---	90	---	ns
Q_{rr}	Reverse Recovery Charge		---	230	---	nC

Notes

1.The EAS data shows Max. rating . The test condition is $VD=-30\text{V}$, $L=3\text{mH}$, $I_{AS}=29\text{A}$

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